

Product Overview

Modular Enterprise Chassis 4 HU



Description

With the modular access platform, MICROSENS offers an open system for a large number of function modules. These are designed both for LAN and WAN applications and also for the implementation of telecommunications and industrial interfaces.

Together with the standard enterprise chassis with 3 HU structural height and 14 module slots, this special carrier chassis is available with 4 HU structural height and 28 module slots.

With the optional management module it is possible to monitor the operating status of the system, such as power supply, temperature and link status of all mounted modules. The access to the management information can be done by Telnet, SNMP or web based management.

19" Chassis 4 HU max. 28 slots (2x 84 DU), without accessories such as power supply (12 DU), Management (6 DU), Fan module (18 DU) and blind covers (6 DU).

Properties

- Maximum flexibility
- Populated front and back
- 28 module slots on 4 HU
- Fully compatible with all modules in the "Access" series
- "Hot swap" of modules
- Central power supply with redundancy option
- Exchangeable fan modules

Order Information

Description

Article Number

19" Chassis 4 HU, max. 28 module slots

MS416010M

Accessories

Description	Article Number
DC 24...60 V power supply (also redundant)	MS416005M
SNMP management module for modular converter systems Rev. B	MS416020-B
Blank cover for 19" Chassis	MS416100
Power cord EU/C13 with locking system, 3x1mm ² (US:AWG18) black 2m	MS190004VS
Power cord UK/C13 with locking system, 3x1mm ² (US:AWG18) black 2m	MS190005VS
Power cord US/C13 with locking system, 3x1mm ² (AWG18) black 2m	MS190006VS

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